

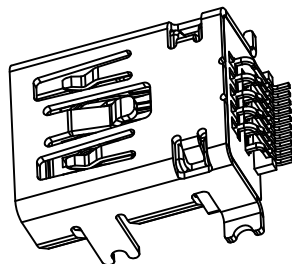
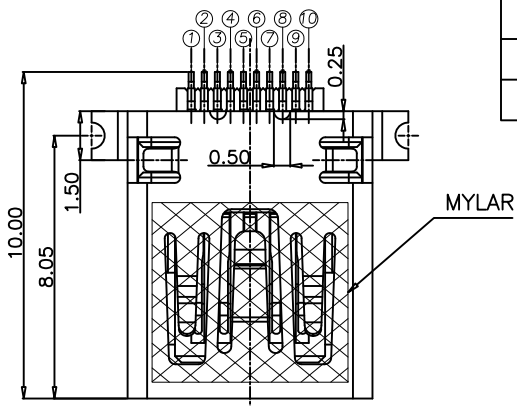


③	CONTACT	10	C5210-EH,T=0.15	Au PLATING
②	HOUSING	1	LCP+GF30%	BLACK
①	SHELL	1	SPCC-SB,T=0.50	MATED SN PLATING
NO.	PART NAME	Q'TY	DESCRIPTION	NOTE

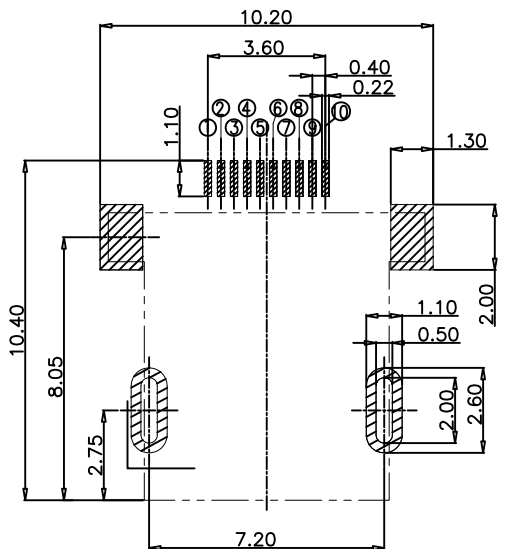
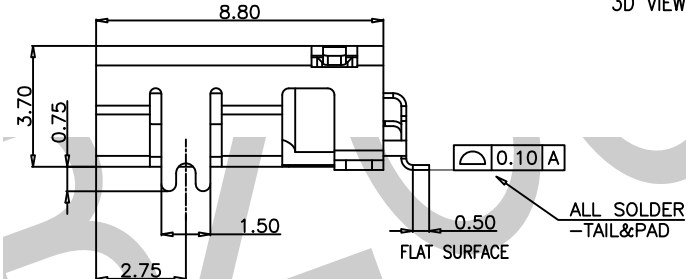
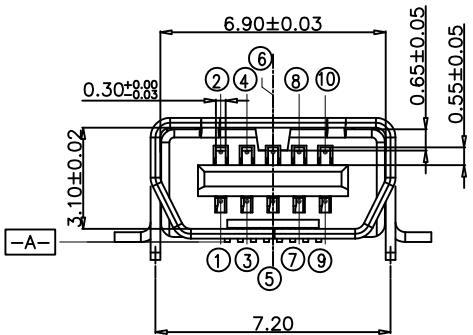
NOTE:

1. ELECTRICAL CHARACTERISTICS  
 1-1. CONTACT RESISTANCE: 80 milliohms MAX.  
 1-2. INSULATION RESISTANCE: 1,000 Megohms MIN.  
 1-3. DIELECTRIC WITHSTANDING VOLTAGE: 500V AC MIN  
 FOR 1 MINUTE.

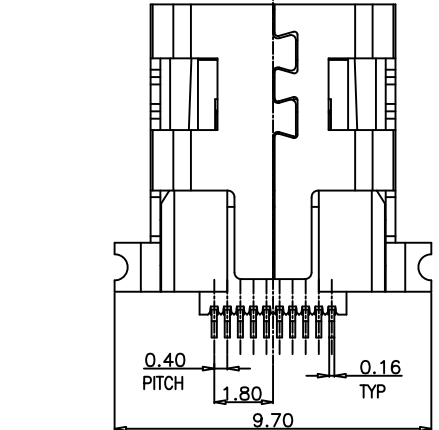
2. MECHANICAL CHARACTERISTICS  
 2-1. RETENTION FORCE: MIN.100gf/PIN  
 3. PLATING: CONTACT AREA 1u"AU PLATED, SMT AREA MATED SN FLASH



3D VIEW



RECOMMENDED PCB LAYOUT(TOP VIEW)  
 GENERAL TOLERANCES: ±0.05



U MIN-F-10-20T-WRS-P-SG-F-RM-001

USB 外壳SMT+DIP脚  
 MIN: MINT USB 包装方式  
 F: 母头(插座) RM: 卷装+麦拉  
 10: 10PIN 塑胶材质: F: LCP  
 外壳材质: 端子电镀:  
 20: 铁壳 T: 镀锡 SG: 亮锡半金  
 端子材质: P: 磷铜  
 90° SMT

TOLERANCE UNLESS OTHERWISE SPECIFIED		<b>BZOC</b> 东莞市柏洲电子有限公司 Dongguan Bzoc Electronics, Ltd	
.X± 0.35	X.*± 1.5'	APR. AX.T	TITLE: MINI USB 10PIN FEMALE CONN. (SMT+DIP TYPE)
.XX± 0.25	.X*± 1.0'	CHK. Y.L	PART NO.
.XXX± 0.15	.XX*± 0.5'	DRA. Y.L	PROJ.
A0	FIRST RELEASE	Y.L	2020.06.01
REV.	ECN. NO.	APR.	DATE
		UNITS. MM	SCALE: 1:1
		CUSTOMER DRAWING	
		SHEET. 1 / 1	